innodisk

Total Solution For Embedded Peripherals

EMPL-21N1

mPCIe to single 2.5GbE LAN module

Customer: _____

Customer Part Number: _____

Innodisk Part Number: _____

Innodisk Model Name: _____

Date: _____

Innodisk Approver	Customer Approver

Table of Contents

REVISION HISTORY

Revision	Description	Date
1.0	First Released	Dec, 2023

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1. Product Introduction

1.1. Overview

Innodisk EMPL-21N1 is designed with standard Mini PCI Express form factor, EMPL-21N1 supports PCIe Gen 2.1 with a single lane to single independent 2.5GbE LAN, optimized for higher performance and lower power. EMPL-21N1 is designed with on-board transformer which brings you a flexible cable design for small form factor or embedded systems.

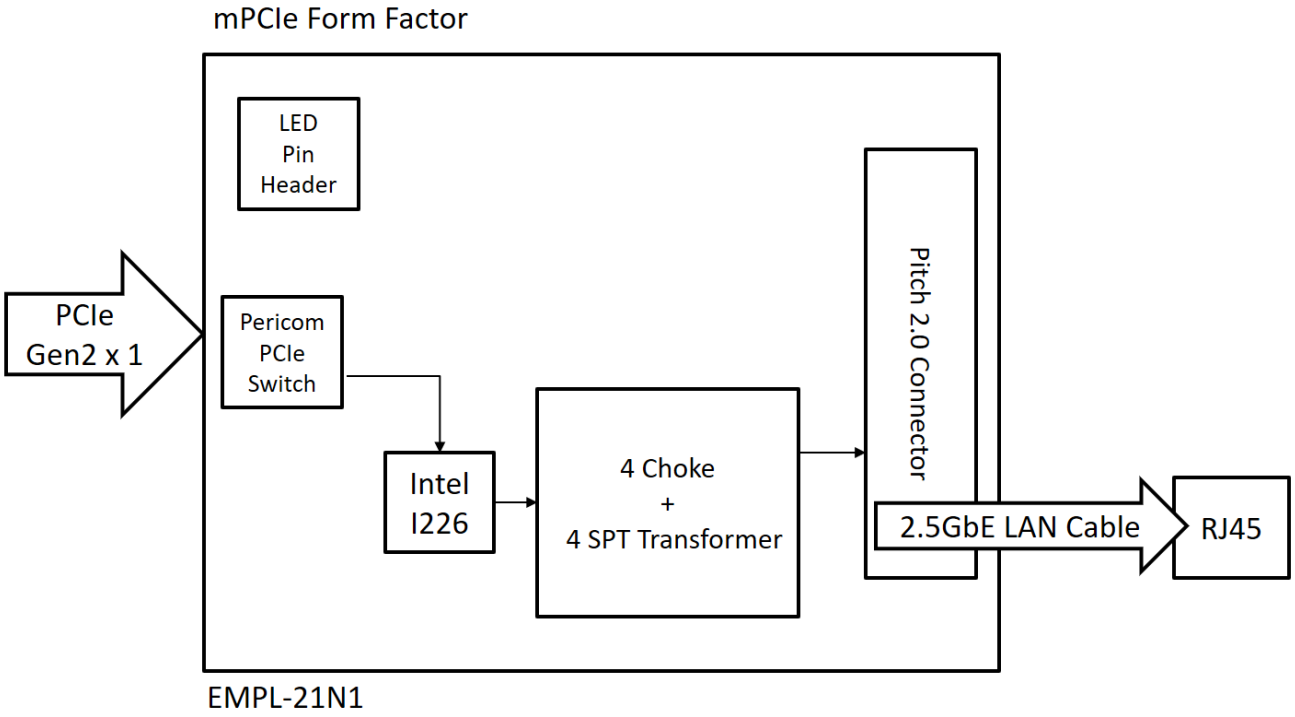


Figure 1: Block Diagram

1.2. Features

- Single 2.5GbE LAN ports
- Complies with EN61000-4-2 (ESD) Air-15kV, Contact-8kV
- Transformer on PCB for flexible cable design
- External LED indicator pin for speed 10/100/1000
- Optional Industrial Temperature (-40°C to +85°C) support
- 30μ" golden finger, 3-year warranty
- Industrial design, manufactured in innodisk Taiwan

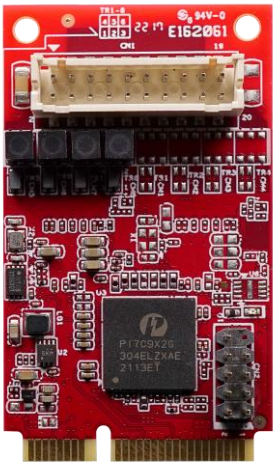


Figure 2: mPCIe Board Picture

Figure 3: 20pin Pitch 2.0 Connector to 1 RJ45 Cable

2. Product Specifications

2.1. Device Parameters

Table 1: Device Parameters

Form Factor	mPCIe
Input I/F	PCI Express 2.1 x 1
Output I/F	2.5GbE LAN x 1
Output Connector	20 Pin Pitch 2.0 Connector
Dimension (WxLxH)	mPCIe Board: 29.85 x 50.8 x 9.35 mm

2.2. Electrical Specifications

2.2.1. Power Requirement

Table 2: Power Requirement

Item	Connector	Rating
Input voltage	mPCIe Golden Finger	+3.3 DC +-5%

2.2.2. Power Consumption

Table 3: Power Consumption

Voltage(V)	RMS(mA)	Max (mA)
3.3	526.1	646

2.3. Environmental Specifications

2.3.1. Temperature Ranges

Table 4: Temperature Ranges

Temperature	Range
Operating	Standard Grade: 0°C to +70°C Industrial Grade: -40°C to +85°
Storage	-55°C to +95°

2.3.2. Humidity

Relative Humidity: 10-95%, non-condensing

2.3.3. Shock and Vibration

Table 5: Shock and Vibration

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.3.4. Mean Time between Failure (MTBF)

Reliability prediction methodology provides the basis for reliability evaluation and analysis. The purpose of the prediction is to predict the life time of the product in units of failure rate and MTBF.

Table 6: Mean Time between Failure (MTBF)

Product	Condition	MTBF (Hours)
EMPL-21N1-C1/W1	The analysis is at 25°C ambient temperature by Telcordia SR-332, Issues 4, Method I, Case 3 under Ground Benign, Controlled environment, 50% operation stress	14,228,773

2.4. CE and FCC Compatibility

EMPL-21N1 conforms to CE and FCC requirements.

2.5. RoHS Compliance

EMPL-21N1 is fully compliant with RoHS directive.

2.6. Hardware

2.6.1. Layout

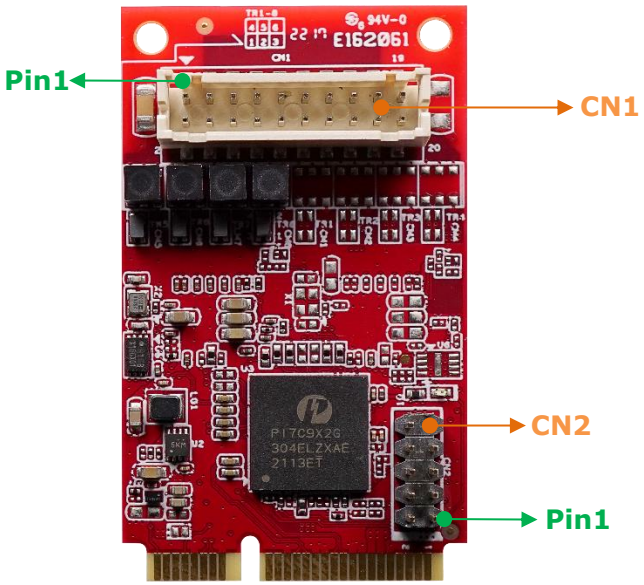


Table 7: mPCIe PCB Layout Legend

Label	Connector Type	Function
CN1	Wire to board SMD 2*10P 180° P:2.0mm H:6.5mm	GbE LAN Signal
CN2	2x5 Pin Header (cut 9pin) P:2.0mm H:3.9mm	LED Signal

2.6.2. Pin Define

Table 8: mPCIe Pin Define

Signal Name	Pin #	Pin #	Signal Name
NC	**51**	**52**	3.3V AUX
NC	**49**	**50**	GND
NC	**47**	**48**	NC
NC	**45**	**46**	NC
GND	**43**	**44**	NC
3.3V AUX	**41**	**42**	NC
3.3V AUX	**39**	**40**	GND
GND	**37**	**38**	NC
GND	**35**	**36**	NC
RX+	**33**	**34**	GND
RX-	**31**	**32**	SMBDATA
GND	**29**	**30**	SMBCLK
GND	**27**	**28**	NC
TX+	**25**	**26**	GND
TX-	**23**	**24**	3.3V AUX
GND	**21**	**22**	PERST#
NC	**19**	**20**	NC
NC	**17**	**18**	GND
GND	**15**	**16**	NC
CLK+	**13**	**14**	NC
CLK-	**11**	**12**	NC
GND	**9**	**10**	NC
GND	**7**	**8**	NC
NC	**5**	**6**	NC
NC	**3**	**4**	GND
PE_WAKE_N	**1**	**2**	3.3V AUX

2.6.3. I/O Connector Mechanical Drawing & Pin Defines

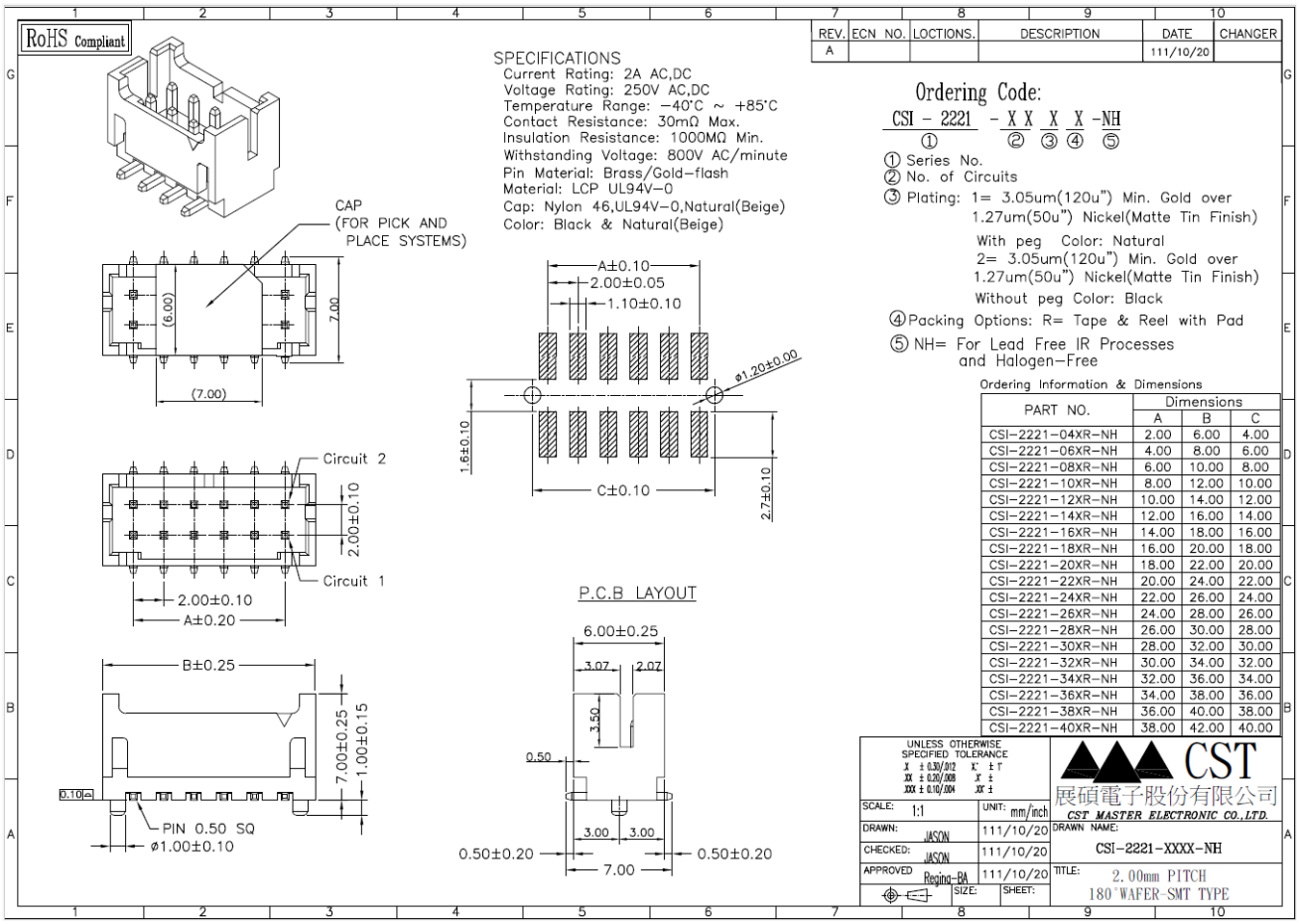


Figure 4: Wire to Board SMD 2*10P Connector Drawing

Table 9: Wire to Board SMD 2*10P Connector (CN1) Pin Define

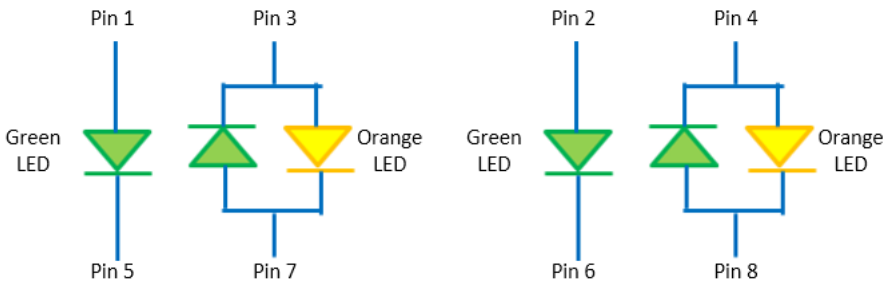
Signal Name	Pin #	Pin #	Signal Name
NC	**2**	**1**	GND
P2_MDI0P_CN	**4**	**3**	P2_MDI1P_CN
P2_MDI0N_CN	**6**	**5**	P2_MDI1N_CN
P2_MDI2P_CN	**8**	**7**	P2_MDI3P_CN
P2_MDI2N_CN	**10**	**9**	P2_MDI3N_CN
P1_MDI0P_CN	**12**	**11**	P1_MDI1P_CN
P1_MDI0N_CN	**14**	**13**	P1_MDI1N_CN
P1_MDI2P_CN	**16**	**15**	P1_MDI3P_CN
P1_MDI2N_CN	**18**	**17**	P1_MDI3N_CN
NC	**20**	**19**	GND

Table 10: 2X5 Pin Header (CN2) Pin Define

Signal Name	Pin #	Pin #	Signal Name
3.3V_B	**1**	**2**	3.3_A
A_SPEED_2500	**3**	**4**	B_SPEED_2500
A_LINK_ACT_N	**5**	**6**	B_LINK_ACT_N
A_LINK_1000_N	**7**	**8**	B_LINK_1000_N
		10	GND

Table 11: LAN LED Table

Speed LED	
10M	OFF
100M	OFF
1G	Orange
2.5G	Green
Link-Activity LED	
Link-up	Green
Tx/Rx Activity	Blinking Green



2.6.4. EMPL-21N1 Mechanical Drawing

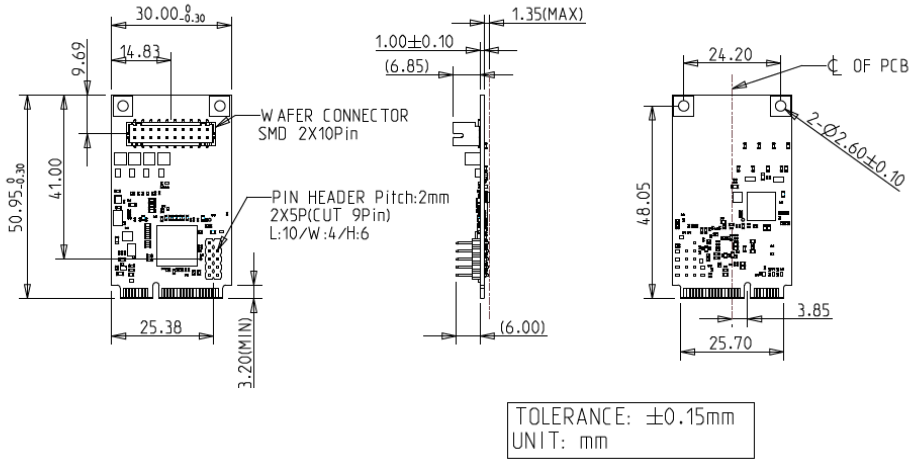


Figure 5: EMPL-21N1 mPCIe Board Drawing

2.6.5. Cable Mechanical Drawing

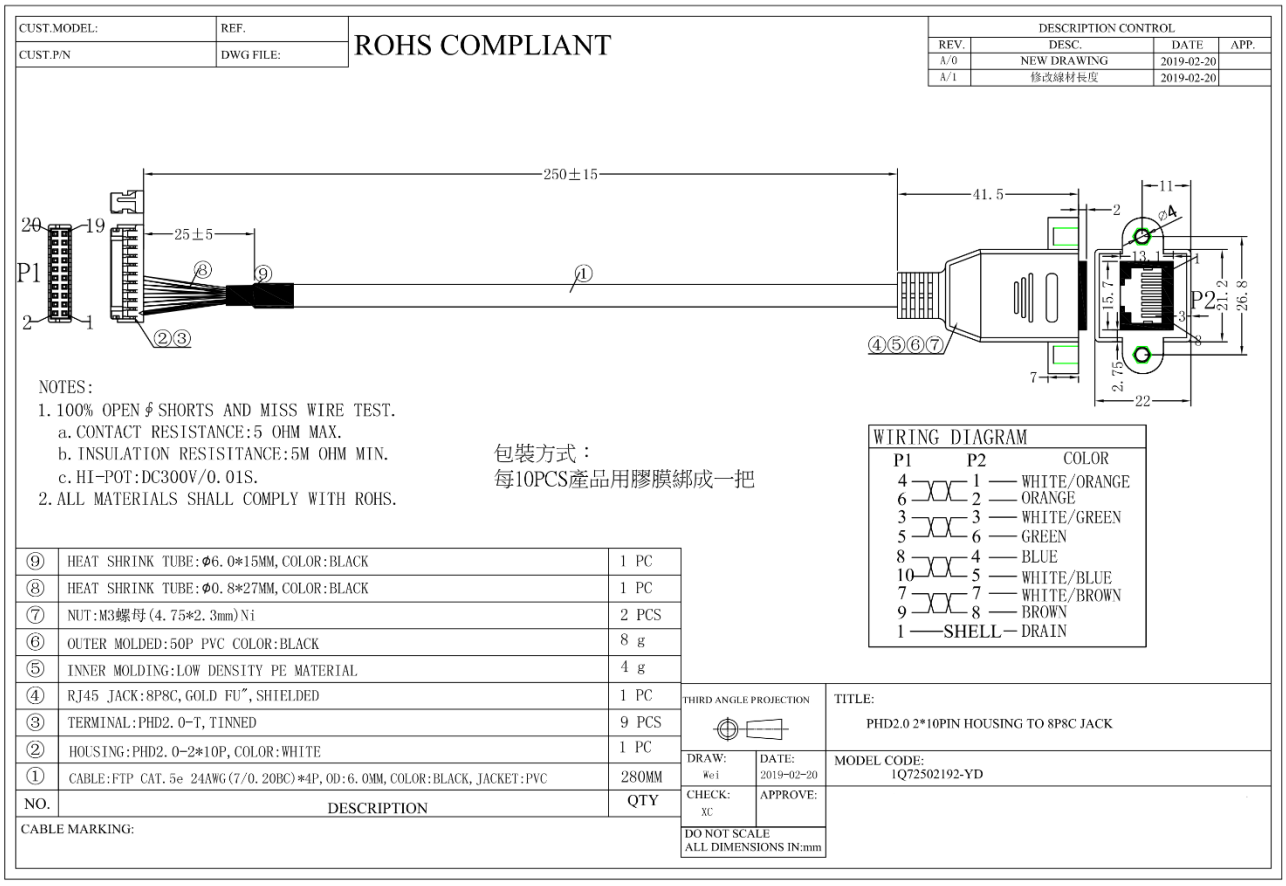


Figure 6: 20pin Pitch 2.0 Connector to 1 RJ45 Cable Drawing

2.6.6. Packing List

- EMPL-21N1 mPCIe Board x 1
- 20pin Pitch 2.0 Connector to 1 RJ45 Cable x 1

2.7. Software Support

Foxville (I225/I226) Operating System Support Matrix:

Operating System / SW	I225 - x86, 64 bit	I226 – x86, 64 bit
Windows 7 / 8 / 8.1	No	
Windows 10 RS5+ / 10S	Yes	
Windows 11	Yes (From ADL, NetAdapterCX)	
Windows Server 2019/2022	Yes (LM/IT sku only)	
Mac OS	Yes (from OS Version 10.16.5)	Yes (from OS Version 12.3)
Linux	Yes (upstream kernel release – from 5.8)	Yes (upstream kernel release – from 5.16.18)
Linux RHEL	Yes | RHEL 8.1 (LM/V sku) | RHEL 8.3 (IT sku)	Yes | RHEL 8.6 (LM/-V/-IT)
DPDK	Yes (from 20.05)	Yes (from 22.07)
FreeBSD	Yes	
Legacy PXE	Yes	Yes (UEFI PXE only)
UEFI 2.4	Yes	
Manufacturing / NVM Programing Tools	Supported on Windows, Linux, x86 Architecture only	

3. Installation Guide

Please download driver from Myinnodisk web site.
https://myinnodisk.innodisk.com/myinnodisk/Login.aspx

Windows driver still can be downloaded from intel official website.
https://www.intel.com/content/www/us/en/download/15084/intel-ethernet-adapter-complete-driver-pack.html

Intel dosen't provide i226 Linux driver for download.
Up Stream Kernel Release from 5.16.18.

4. Appedix

innodisk

宜鼎國際股份有限公司

Innodisk Corporation

REACH Declaration

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: https://www.innodisk.com/

Innodisk Corporation pursues its social responsibility for global environmental preservation by committing to be compliant with REACH regulation (REGULATION (EC) No 1907/2006).
We hereby confirm that the product(s),

Scope: Flash Memory, DRAM Module and Embedded Peripherals Products.

■ The standard products of **not listed in** the ***Appendix2*** meet the requirements of REACH SVHC regulations(SVHCs < 0.1% in Article), as described in the candidate list table currently including 233 substances (release date: 17-Jan-2023) and shown on the ECHA website. https://echa.europa.eu/candidate-list-table

■ The standard products listed in the ***Appendix2*** contain(s) one or more hazardous substances or constituents exceeding 0.1 % by weight in article if not otherwise specified in candidate list table.
Where the threshold value is exceeded, the substances in question are to be declared in accompanying. (SVHCs > 0.1% in Article).

■ Comply with REACH Annex XVII.

Guarantor

Company name 公司名稱： Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人： Yichuan Chen 陳怡全

Company Representative Title 公司代表人職稱： QA Manager 品保經理

Date 日期：2023 / 02 / 09

1

innodisk

宜鼎國際股份有限公司
Innodisk Corporation

Tel:(02)7703-3000 Internet: https://www.innodisk.com/

RoHS 自我宣告書(RoHS Declaration of Conformity)

Manufacturer Products: All Innodisk EM FLASH, DRAM and EP products

一、 宜鼎國際股份有限公司（以下稱本公司）特此保證售予貴公司之所有產品，皆符合歐盟 2011/65/EU 及(EU) 2015/863 關於 RoHS 之規範要求。
Innodisk Corporation declares that all products sold to the company, are complied with European Union RoHS Directive (2011/65/EU) and (EU) 2015/863 requirement.

二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。
Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

三、 本公司聲明我們的產品符合 RoHS 指令的附件中 7(a)、7(c)-I、6(c)允許豁免。
We declare, our products permitted by the following exemptions specified in the Annex of the RoHS directive.

※ 7(a) Lead in high melting temperature type solders(i.e. lead-based alloys containing 85% by weight or more lead).

※ 7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectric devices, or in a glass or ceramic matrix compound.

※ 6(c) Copper alloy containing up to 4% lead by weight. (This exemption applies to products that use antennas)

Name of hazardous substance	Limited of RoHS ppm（mg/kg）
鉛（Pb）	< 1000 ppm
汞（Hg）	< 1000 ppm
鎘（Cd）	< 100 ppm
六價鉻（Cr 6+）	< 1000 ppm
多溴聯苯（PBBs）	< 1000 ppm
多溴二苯醚（PBDEs）	< 1000 ppm
鄰苯二甲酸二(2-乙基己基)酯（DEHP）	< 1000 ppm
鄰苯二甲酸丁酯苯甲酯（BBP）	< 1000 ppm
鄰苯二甲酸二丁酯（DBP）	< 1000 ppm
鄰苯二甲酸二異丁酯（DIBP）	< 1000 ppm

宜鼎國際股份有限公司
Innodisk Corporation

立 保 證 書 人 (Guarantor)

Company name 公司名稱： Innodisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人： 簡川勝

Company Representative Title 公司代表人職稱： Chairman 董事長

Date 日期： 2023 / 06 / 14

DEKRA

Statement of Conformity

Issued Date: July 24, 2023
Report No. : 2360506R-0E3012100115-A

This is to certify that the following designated product

Product	**: mPCIe to Dual Isolated 2.5GbE LAN Module**
Trademark	**: Innodisk**
Model Number	**: EMPL-2#N1**
	#: 1: 1port; 2: 2port
Company Name	**: Innodisk Corporation**

This product, which has been issued the test report listed as above in DEKRA Testing and Certification Co., Ltd. Laboratory, is based on a single evaluation of one sample and confirmed to comply with the requirements of the following EMC standard.

EN 55032:2015/A1:2020, Class B

EN 55035:2017/A11:2020
IEC 61000-4-2 Ed. 2.0:2008
IEC 61000-4-3 Ed. 4.0:2020
IEC 61000-4-4 Ed. 3.0:2012
IEC 61000-4-6 Ed. 4.0:2013
IEC 61000-4-8 Ed. 2.0:2009

TEST LABORATORY

Vincent Lin / Director

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TEL:+886-2-8601-3788 FAX:+886-2-8601-3789 Email: info.tw@dekra.com http://www.dekra.com.tw

DEKRA

Statement of Conformity

Issued Date: July 24, 2023
Report No. : 2360506R-0E3012110014-A

This is to certify that the following designated product

Product	**: mPCIe to Dual Isolated 2.5GbE LAN Module**
Trademark	**: Innodisk**
Model Number	**: EMPL-2#N1**
	#: 1: 1port; 2: 2port
Company Name	**: Innodisk Corporation**

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FCC CFR Title 47 Part 15 Subpart B:2021, Class B

TEST LABORATORY

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DEKRA

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BS EN 55035:2017+A11:2020
BS EN 61000-4-2:2009
BS EN IEC 61000-4-3:2020
BS EN 61000-4-4:2012
BS EN 61000-4-6:2014
BS EN 61000-4-8:2010

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DEKRA

Statement of Conformity

Issued Date: July 24, 2023
Report No. : 2360506R-0E3012150009-A

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Model Number	**: EMPL-2#N1**
	#: 1: 1port; 2: 2port
Company Name	**: Innodisk Corporation**

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ICES-003 Issue 7:2020, Class B

TEST LABORATORY

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January 2, 2024